



Material Content Data Sheet



Sales Product Name		IKD03N60RF		Issued		26. September 2017		
MA#		MA000942942						
Package		PG-TO252-3-313		Weight*		316.44 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.433	0.14	0.14	1369	1369
leadframe	non noble metal	iron	7439-89-6	0.147	0.05		465	
	inorganic material	phosphorus	7723-14-0	0.044	0.01		140	
	non noble metal	copper	7440-50-8	147.096	46.49	46.55	464841	465446
wire	non noble metal	aluminium	7429-90-5	0.566	0.18	0.18	1789	1789
encapsulation	organic material	carbon black	1333-86-4	1.432	0.45		4525	
	plastics	epoxy resin	-	25.057	7.92		79182	
	inorganic material	silicondioxide	60676-86-0	116.692	36.88	45.25	368761	452468
leadfinish	non noble metal	tin	7440-31-5	3.740	1.18	1.18	11819	11819
plating	inorganic material	phosphorus	7723-14-0	0.003	0.00		11	
	non noble metal	nickel	7440-02-0	1.421	0.45	0.45	4489	4500
solder	noble metal	silver	7440-22-4	0.015	0.00		48	
	non noble metal	tin	7440-31-5	0.012	0.00		39	
	non noble metal	lead	7439-92-1	0.582	0.18	0.18	1840	1927
heatspreader	non noble metal	iron	7439-89-6	0.019	0.01		61	
	inorganic material	phosphorus	7723-14-0	0.006	0.00		18	
	non noble metal	copper	7440-50-8	19.177	6.06	6.07	60603	60682
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com